

MJH11019G Datasheet



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DiGi Electronics Part Number MJH11019G-DG

Manufacturer onsemi

Manufacturer Product Number MJH11019G

Description TRANS PNP DARL 200V 15A TO247-3

Detailed Description Bipolar (BJT) Transistor PNP - Darlington 200 V 15 A

3MHz 150 W Through Hole TO-247-3



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Purchase and inquiry

Manufacturer Product Number:	Manufacturer:
MJH11019G	onsemi
Series:	Product Status:
	Active
Transistor Type:	Current - Collector (Ic) (Max):
PNP - Darlington	15 A
Voltage - Collector Emitter Breakdown (Max):	Vce Saturation (Max) @ lb, Ic:
200 V	4V @ 150mA, 15A
Current - Collector Cutoff (Max):	DC Current Gain (hFE) (Min) @ Ic, Vce:
1mA	400 @ 10A, 5V
Power - Max:	Frequency - Transition:
150 W	3MHz
Operating Temperature:	Mounting Type:
-65°C ~ 150°C (TJ)	Through Hole
Package / Case:	Supplier Device Package:
TO-247-3	TO-247-3
Base Product Number:	
МЈН11019	

Environmental & Export classification

RoHS Status:	Moisture Sensitivity Level (MSL):
ROHS3 Compliant	Not Applicable
REACH Status:	ECCN:
REACH Unaffected	EAR99
HTSUS:	
8541.29.0095	



Complementary Darlington Silicon Power Transistors

MJH11017, MJH11019, MJH11021 (PNP) MJH11018, MJH11020, MJH11022 (NPN)

These devices are designed for use as general purpose amplifiers, low frequency switching and motor control applications.

Features

- High DC Current Gain @ 10 Adc h_{FE} = 400 Min (All Types)
- Collector-Emitter Sustaining Voltage

• Low Collector-Emitter Saturation Voltage

$$V_{CE(sat)} = 1.2 \text{ V (Typ)} @ I_C = 5.0 \text{ A}$$

= 1.8 V (Typ) @ $I_C = 10 \text{ A}$

- Monolithic Construction
- These are Pb-Free Devices

MAXIMUM RATINGS

Rating	Symbol	Max	Unit
Collector-Emitter Voltage MJH11018, MJH11017 MJH11020, MJH11019 MJH11022, MJH11021	V _{CEO}	150 200 250	Vdc
Collector-Base Voltage MJH11018, MJH11017 MJH11020, MJH11019 MJH11022, MJH11021	V _{CB}	150 200 250	Vdc
Emitter-Base Voltage	V _{EB}	5.0	Vdc
Collector Current – Continuous – Peak (Note 1)	I _C	15 30	Adc
Base Current	Ι _Β	0.5	Adc
Total Device Dissipation @ T _C = 25°C Derate above 25°C	P _D	150 1.2	W W/°C
Operating and Storage Junction Temperature Range	T _J , T _{stg}	-65 to +150	°C

THERMAL CHARACTERISTICS

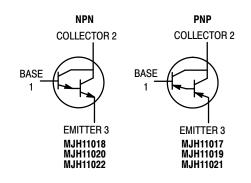
Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	0.83	°C/W

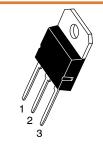
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1

1. Pulse Test: Pulse Width = 5.0 ms, Duty Cycle ≤ 10%.

15 AMPERE DARLINGTON COMPLEMENTARY SILICON POWER TRANSISTORS 150-250 VOLTS, 150 WATTS





SOT-93 (TO-218) CASE 340D STYLE 1



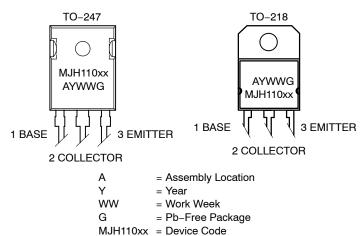
TO-247 CASE 340L STYLE 3

NOTE: Effective June 2012 this device will be available only in the TO-247 package. Reference FPCN# 16827.

ORDERING INFORMATION

See detailed ordering and shipping information in on page 2 of this data sheet.

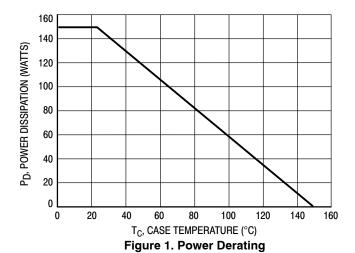
MARKING DIAGRAMS



xx = 17, 19, 21, 18, 20, 22

ORDERING INFORMATION

Device Order Number	Package Type	Shipping
MJH11017G	TO-218 (Pb-Free)	30 Units / Rail
MJH11018G	TO-218 (Pb-Free)	30 Units / Rail
MJH11019G	TO-218 (Pb-Free)	30 Units / Rail
MJH11020G	TO-218 (Pb-Free)	30 Units / Rail
MJH11021G	TO-218 (Pb-Free)	30 Units / Rail
MJH11022G	TO-218 (Pb-Free)	30 Units / Rail
MJH11017G	TO-247 (Pb-Free)	30 Units / Rail
MJH11018G	TO-247 (Pb-Free)	30 Units / Rail
MJH11019G	TO-247 (Pb-Free)	30 Units / Rail
MJH11020G	TO-247 (Pb-Free)	30 Units / Rail
MJH11021G	TO-247 (Pb-Free)	30 Units / Rail
MJH11022G	TO-247 (Pb-Free)	30 Units / Rail



EDICTICS (T. 05%) unless atherwise materily

ELECTRICAL CHARACTERISTICS	$(T_C = 25^{\circ}C \text{ unless otherwise noted})$
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Characteristic		Symbol	Min	Max	Unit
OFF CHARACTERISTICS		•		_	
Collector–Emitter Sustaining Voltage (Note 2) (I _C = 0.1 Adc, I _B = 0)	MJH11017, MJH11018 MJH11019, MJH11020 MJH11021, MJH11022	V _{CEO(sus)}	150 200 250	- - -	Vdc
Collector Cutoff Current	MJH11017, MJH11018 MJH11019, MJH11020 MJH11021, MJH11022	I _{CEO}	- - -	1.0 1.0 1.0	mAdc
Collector Cutoff Current $(V_{CE} = Rated\ V_{CB},\ V_{BE(off)} = 1.5\ Vdc)$ $(V_{CE} = Rated\ V_{CB},\ V_{BE(off)} = 1.5\ Vdc,\ T_J = 150^{\circ}C)$		I _{CEV}	_ _	0.5 5.0	mAdc
Emitter Cutoff Current (V _{BE} = 5.0 Vdc I _C = 0)		I _{EBO}	-	2.0	mAdc
ON CHARACTERISTICS (Note 2)					
DC Current Gain $ \begin{aligned} (I_C &= 10 \text{ Adc, V}_{CE} = 5.0 \text{ Vdc)} \\ (I_C &= 15 \text{ Adc, V}_{CE} = 5.0 \text{ Vdc)} \end{aligned} $		h _{FE}	400 100	15,000 -	-
Collector–Emitter Saturation Voltage ($I_C = 10$ Adc, $I_B = 100$ mA) ($I_C = 15$ Adc, $I_B = 150$ mA)		V _{CE(sat)}	- -	2.5 4.0	Vdc
Base–Emitter On Voltage (I _C = 10 A, V _{CE} = 5.0 Vdc)		V _{BE(on)}	_	2.8	Vdc
Base–Emitter Saturation Voltage (I _C = 15 Adc, I _B = 150 mA)		V _{BE(sat)}	-	3.8	Vdc
DYNAMIC CHARACTERISTICS			_		
Current-Gain Bandwidth Product (I _C = 10 Adc, V _{CE} = 3.0 Vdc, f = 1.0 MHz)		f _T	3.0	-	-
Output Capacitance MJH11018, MJH11020, MJH11 ($V_{CB} = 10 \text{ Vdc}$, $I_E = 0$, $f = 0.1 \text{ MHz}$) MJH		C _{ob}	_ _	400 600	pF

SWITCHING CHARACTERISTICS

Small-Signal Current Gain (I_C = 10 Adc, V_{CE} = 3.0 Vdc, f = 1.0 kHz)

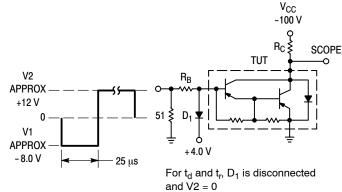
			Тур	ical	
Characteristic			NPN	PNP	Unit
Delay Time		t _d	150	75	ns
Rise Time	$(V_{CC} = 100 \text{ V}, I_{C} = 10 \text{ A}, I_{B} = 100 \text{ mA}$ $V_{BE(off)} = 5.0 \text{ V}) \text{ (See Figure 2)}$	t _r	1.2	0.5	μs
Storage Time		t _s	4.4	2.7	μs
Fall Time		t _f	2.5	2.5	μs

h_{fe}

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

2. Pulse Test: Pulse Width = $300 \mu s$, Duty Cycle $\leq 2.0\%$.

R_B & R_C varied to obtain desired current levels D₁, must be fast recovery types, e.g.: 1N5825 used above I_B \approx 100 mA MSD6100 used below I_B \approx 100 mA



 t_r , $t_f \le 10 \text{ ns}$ Duty Cycle = 1.0%

For NPN test circuit, reverse diode and voltage polarities.

Figure 2. Switching Times Test Circuit

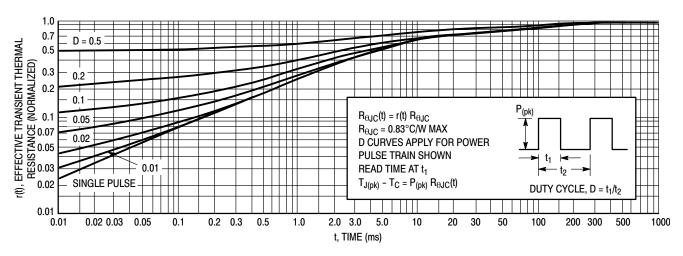


Figure 3. Thermal Response

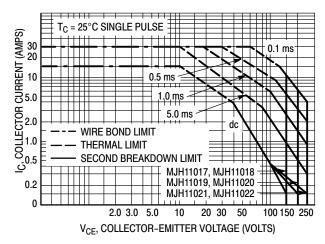


Figure 4. Maximum Rated Forward Bias Safe Operating Area (FBSOA)

FORWARD BIAS

There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate I_C – V_{CE} limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Figure 4 is based on $T_{J(pk)} = 150^{\circ}C$; T_C is variable depending on conditions. Second breakdown pulse limits are valid for duty cycles to 10% provided $T_{J(pk)} \le 150^{\circ}C$. $T_{J(pk)}$ may be calculated from the data in Figure 3. At high case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by second breakdown.

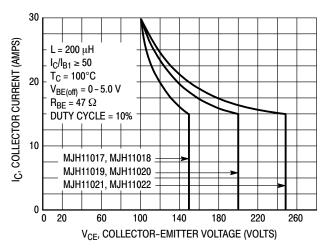


Figure 5. Maximum Rated Reverse Bias Safe Operating Area (RBSOA)

REVERSE BIAS

For inductive loads, high voltage and high current must be sustained simultaneously during turn-off, in most cases, with the base to emitter junction reverse biased. Under these conditions the collector voltage must be held to a safe level at or below a specific value of collector current. This can be accomplished by several means such as active clamping, RC snubbing, load line shaping, etc. The safe level for these devices is specified as Reverse Bias Safe Operating Area and represents the voltage-current conditions during reverse biased turn-off. This rating is verified under clamped conditions so that the device is never subjected to an avalanche mode. Figure 5 gives RBSOA characteristics.

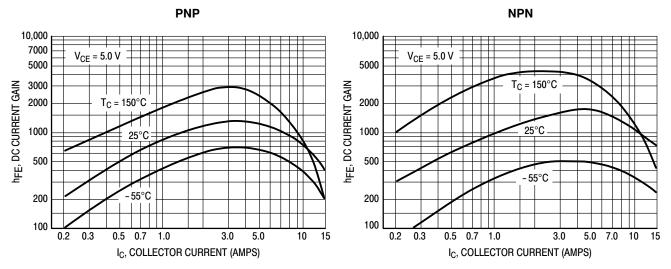


Figure 6. DC Current Gain

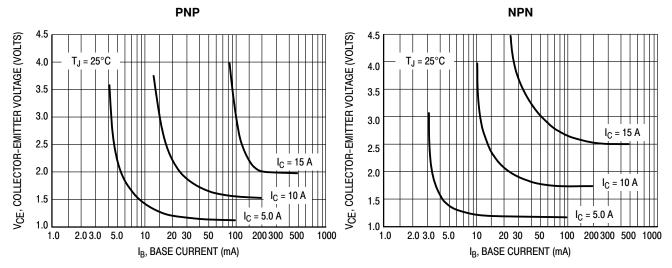


Figure 7. Collector Saturation Region

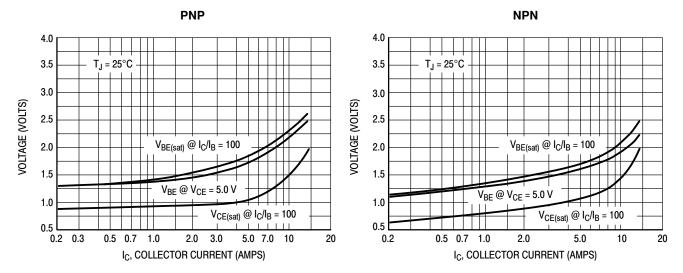


Figure 8. "On" Voltages

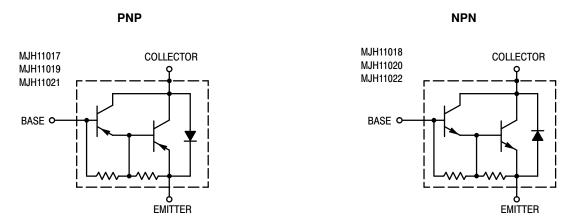
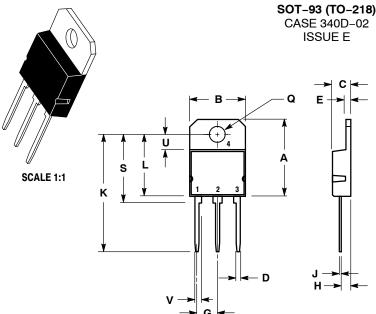


Figure 9. Darlington Schematic



MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS

DATE 03 JAN 2002



STYLE 1: PIN 1. E

PIN 1. BASE 2. COLLECTOR 3. EMITTER 4. COLLECTOR STYLE 2: PIN 1. ANODE 2. CATHOD

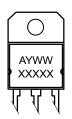
CATHODE
 ANODE
 CATHODE

NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI
 Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: MILLIMETER.

	MILLIMETERS		INC	HES
DIM	MIN	MAX	MIN	MAX
Α		20.35		0.801
В	14.70	15.20	0.579	0.598
C	4.70	4.90	0.185	0.193
D	1.10	1.30	0.043	0.051
Е	1.17	1.37	0.046	0.054
G	5.40	5.55	0.213	0.219
Н	2.00	3.00	0.079	0.118
J	0.50	0.78	0.020	0.031
K	31.00	REF	1.220	REF
L		16.20		0.638
Q	4.00	4.10	0.158	0.161
S	17.80	18.20	0.701	0.717
U	4.00 REF		0.157	REF
٧	1.75 REF		0.0)69

GENERIC MARKING DIAGRAM*



A = Assembly Location

Y = Year WW = Work Week XXXXX = Device Code

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

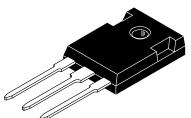
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MECHANICAL CASE OUTLINE

PACKAGE DIMENSIONS



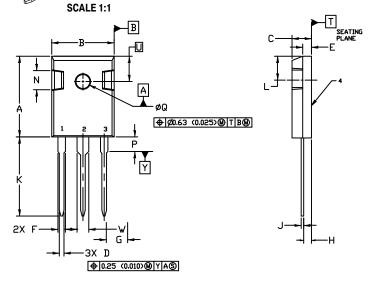
TO-247 CASE 340L ISSUE G

DATE 06 OCT 2021

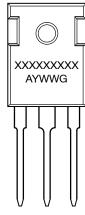
NOTES:

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: MILLIMETER

	MILLIMETERS		INCHES		
DIM	MIN.	MAX.	MIN.	MAX.	
Α	20.32	21.08	0.800	0.830	
В	15.75	16.26	0.620	0.640	
С	4.70	5.30	0.185	0.209	
D	1.00	1.40	0.040	0.055	
Ε	1.90	2.60	0.075	0.102	
F	1.65	2.13	0.065	0.084	
G	5.45 BSC		0.215 BSC		
Н	1.50	2.49	0.059	0.098	
J	0.40	0.80	0.016	0.031	
К	19.81	20.83	0.780	0.820	
L	5.40	6.20	0.212	0.244	
N	4.32	5.49	0.170	0.216	
Р		4.50		0.177	
Q	3.55	3.65	0.140	0.144	
U	6.15 BSC		U 6.15 BSC 0.242 BSC		BSC
W	2.87	3.12	0.113	0.123	



GENERIC MARKING DIAGRAM*



STYLE 1: PIN 1. GATE 2. DRAIN 3. SOURCE 4. DRAIN

PIN 1. CATHODE 2. ANODE

3. GATE 4. ANODE

STYLE 5:

STYLE 2: PIN 1. ANODE 2. CATHODE (S) 3. ANODE 2 4. CATHODES (S)

PIN 1. MAIN TERMINAL 1 2. MAIN TERMINAL 2

3. GATE 4. MAIN TERMINAL 2

STYLE 6:

STYLE 3: PIN 1. BASE 2. COLLECTOR 3. EMITTER 4. COLLECTOR STYLE 4: PIN 1. GATE 2. COLLECTOR 3. EMITTER 4. COLLECTOR

XXXXX = Specific Device Code = Assembly Location Α

Υ = Year WW = Work Week = Pb-Free Package G

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "■", may or may not be present. Some products may not follow the Generic Marking.

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DESCRIPTION:	TO-247		PAGE 1 OF 1	

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